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Class	Subclass

ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

<p>P O.I.P.E. SCANNED Q.A.</p>	<p>PATENT DATE</p>
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APPLICATION NO.	CONT/PRIOR	CLASS	SUBCLASS	ART UNIT	EXAMINER
09/981505		438	6 75	2812	Tsay

APPLICANTS

Donald Olgado
Joseph Stevens
Alexander Lerner

TITLE

Planarization of metal layers on a semiconductor wafer through non-contact de-plating and control with endpoint detection

PTO-2040
12/99

ISSUING CLASSIFICATION								
ORIGINAL			CROSS REFERENCE(S)					
CLASS	SUBCLASS		CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
INTERNATIONAL CLASSIFICATION								

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<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
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	_____ (Primary Examiner) _____ (Date)			ISSUE FEE	
Amount Due				Date Paid	
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